

SHEET 1 OF 1

INFORMATION DISCLOSURE CITATION IN AN APPLICATION		DOCKET NUMBER SHX 354	APPLICATION NUMBER 10/543,162			
		APPLICANT(S) Motohide Matsui, Masato Murakami				
		FILING DATE July 21, 2005	GROUP ART UNIT Not yet assigned			
		U.S. PATENT DOCUMENTS				
EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FIL. DATE IF APPROP.
FOREIGN PATENT DOCUMENTS						
	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB CLASS	TRANSLATION YES NO
/D.M./	05-229820	7/9/1993	Japan			X
OTHER DOCUMENTS						
/D.M./	<i>Joining of melt-textured YBCO: a direct contact method</i> , Chen et al., <u>Institute of Physics Publishing Superconductor Science and Technology</u> , Vol. 15, pp. 672-674, April 2002.					
/D.M./	<i>Processing, microstructure and characterization of artificial joins in top seeded melt grown Y-Ba-Cu-O</i> , Cardwell et al., <u>Institute of Physics Publishing Superconductor Science and Technology</u> , Vol. 15, pp 639-647, April 2002.					
/D.M./	<i>Project of RE123 Bulk Superconductors Fabrication in a Microgravity Environment</i> , Sakai et al., <u>Cryogenics</u> , Vol. 34, pp. 561-568, June 1999.					
EXAMINER	/Douglas Mc Ginty/		DATE CONSIDERED	08/27/2008		